

## **Description**

The AU02 is a fast recovery diode of 400 V / 0.8 A. The maximum  $t_{\rm rr}$  of 400 ns is realized by optimizing a life-time control.

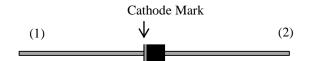
#### **Features**

•	V <sub>RM</sub> 400	V
•	$I_{F(AV)}0.8$	A
	V <sub>F</sub>	
•	t <sub>rr1</sub> 400 r	ıs

• Bare Leads: Pb-free (RoHS Compliant)

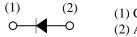
## **Package**

Axial ( $\varphi$ 2.4 × 2.9L /  $\varphi$ 0.57)



# **Applications**

- Secondary Side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck and Buck-boost Converter)



- (1) Cathode
- (2) Anode

Not to scale

# **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C

Parameter	Symbol	Conditions	Rating	Unit
Peak Repetitive Reverse Voltage	V <sub>RSM</sub>		450	V
Repetitive Reverse Voltage	$V_{RM}$		400	V
Average Forward Current	I <sub>F(AV)</sub>	See Figure 2 and Figure 3	0.8	A
Surge Forward Current	$I_{FSM}$	Half cycle sine wave, positive side, 10 ms, 1 shot	25	A
I <sup>2</sup> t Limiting Value	$I^2t$	$1 \text{ ms} \le t \le 10 \text{ ms}$	3.1	$A^2s$
Junction Temperature	T <sub>J</sub>		-40 to 150	°C
Storage Temperature	$T_{STG}$		-40 to 150	°C

## **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Dron	$V_{\mathrm{F}}$	$T_J = 25  ^{\circ}\text{C}, I_F = 0.8  \text{A}$	_	_	1.3	V
Forward Voltage Drop		$T_J = 100  ^{\circ}\text{C},  I_F = 0.8  \text{A}$		0.86	_	V
Reverse Leakage Current	$I_R$	$V_R = V_{RM}$	_		10	μΑ
Reverse Leakage Current Under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 100  ^{\circ}C$			250	μΑ
	t <sub>rr1</sub>	$I_F = I_{RP} = 10 \text{ mA},$ 90% recovery point, $T_J = 25 ^{\circ}\text{C}$	_	_	400	ns
Reverse Recovery Time	t <sub>rr2</sub>	$I_F = 10 \text{ mA},$ $I_{RP} = 20 \text{ mA},$ $75\% \text{ recovery point},$ $T_J = 25 \text{ °C}$	_	_	180	ns
Thermal Resistance (1)	R <sub>th(J-L)</sub>	See Figure 1			22	°C/W

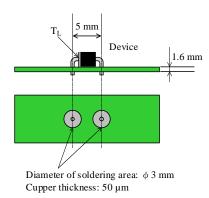
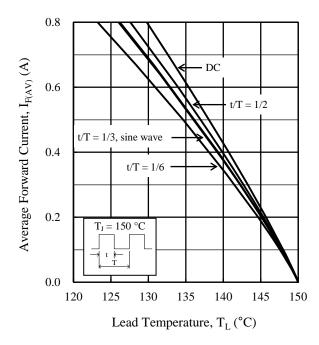


Figure 1 Lead Temperature Measurement Conditions

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 $<sup>\</sup>overline{{}^{(1)}R_{th\;(J\text{-}L)}}$  is thermal resistance between junction and lead.

## **Rating and Characteristic Curves**



 $Figure~2.~~I_{F(AV)}~vs.~T_L~Typical~Characteristics^{(2)}$  $(V_R = 0 V)$ 

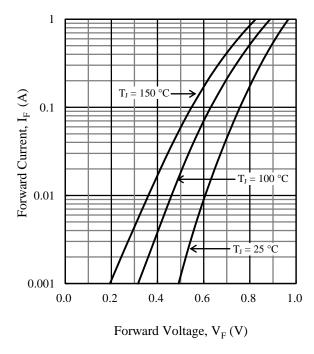


Figure 4. V<sub>F</sub> vs. I<sub>F</sub> Typical Characteristics

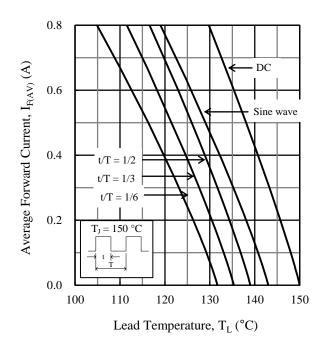


Figure 3.  $I_{F(AV)}$  vs.  $T_L$  Typical Characteristics<sup>(2)</sup>  $(V_R = 400 \text{ V})$ 

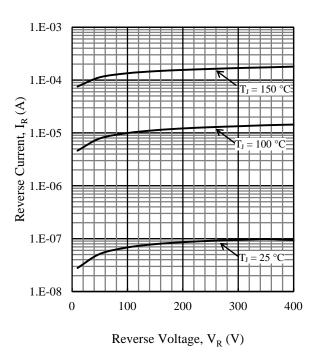
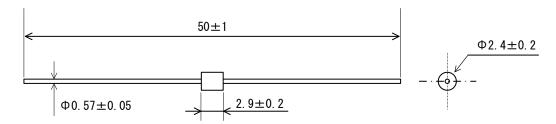


Figure 5. V<sub>R</sub> vs. I<sub>R</sub> Typical Characteristics

<sup>&</sup>lt;sup>(2)</sup> See Figure 1 for the lead temperature measurement conditions.

## **Physical Dimensions**

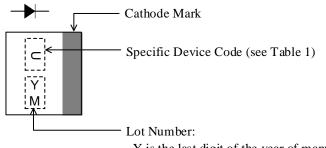
• Axial  $(\phi 2.4 \times 2.9 L / \phi 0.57)$ 



#### **NOTES:**

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time, within the following limits: Flow:  $260 \pm 5$  °C /  $10 \pm 1$  s, 2 times Soldering Iron:  $380 \pm 10$  °C /  $3.5 \pm 0.5$  s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

## **Marking Diagram**



Y is the last digit of the year of manufacture (0 to 9) M is the month of the year (1 to 9, O, N or D)

Table 1. Specific Device Code

Specific Device Code	Part Number
U	AU02

#### NOTE:

- Marked in yellow-based color

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DSGN-AEZ-16003